



20m/30m kit

- T1 1.6 uH secondary, 21T of #30, (13 in.), on T30-6 core (yellow) primaries 10T each of #30, (2 x 8 in.), wound bifilar primary wound on top of secondary
- L1 4.0 uH, 33T of #30, (17 in.), on T30-6 core (yellow)
- T2 primary 6T of #30, (10 in.), wire on BN-61-2402 core secondaries 2T bifilar of #30, (2 x 5 in.)
- RFC1 4 turns #26, (5 in.), on BN-43-2402 core
- T3 secondary 5T of #30, (9 in.), on BN-61-2402 core primaries 3T each of #30, (2 x 6 in.), wound bifilar
- L2 0.77 uH, 16T #26, (11 in.), on T37-6 core (yellow)
- L3 0.77 uH, 16T #26, (11 in.), on T37-6 core (yellow)

Note: Components mounted to the bottom of the board include size 1206 SMT capacitors C50 through C73 and SOICs U1, U2, U3, U5, U6, U7 and U8